8NM60-FD Power MOSFET

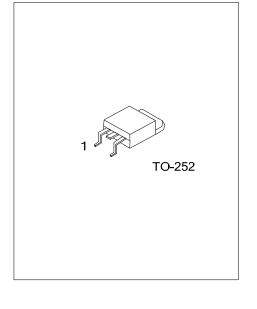
8A, 600V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

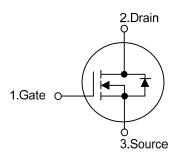
The **UTC 8NM60-FD** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)}$ < 0.82 Ω @ V_{GS} = 10V, I_{D} = 4.0A
- * Fast Switching Capability
- * Avalanche Energy Tested
- * Improved dv/dt Capability, High Ruggedness



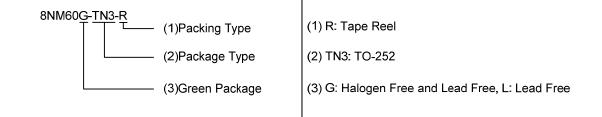
■ SYMBOL



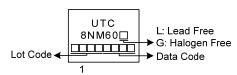
■ ORDERING INFORMATION

Ordering Number		Daakana	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
8NM60L-TN3-R	8NM60G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



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8NM60-FD Power MOSFET

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	600	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous	I_{D}	8	Α	
	Pulsed (Note 2)	I_{DM}	24	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	80	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6	V/ns	
Power Dissipation		P_D	62	W	
Junction Temperature		T_J	+150	°C	
Storage Temperature		T_{STG}	-55 ~ + 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=66mH, I_{AS} =1.55A, V_{DD} =2.3V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 8.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	$\theta_{ m JC}$	2	°C/W	

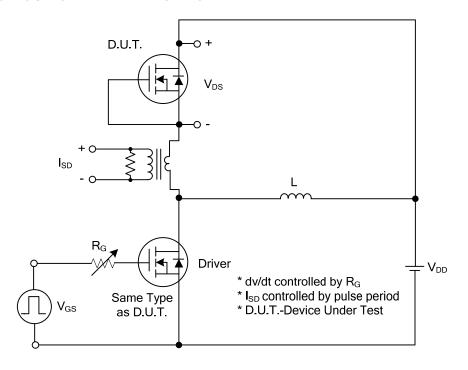
■ **ELECTRICAL CHARACTERISTICS** (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	600			V		
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$			10	μΑ		
Gate- Source Leakage Current	Forward		$V_{GS} = 30V, V_{DS} = 0V$			100	nA		
	Reverse	I _{GSS}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V		
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 4.0A$			0.82	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		C _{ISS}			452		pF		
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0 MHz		381		pF		
Reverse Transfer Capacitance		C _{RSS}			43		pF		
SWITCHING CHARACTERISTICS									
Total Gate Charge (Note 1)		Q_G	V _{DS} =200V, V _{GS} =10V, I _D =8.0A,				nC		
Gate to Source Charge		Q_{GS}	I _G =1mA (Note 1, 2)				nC		
Gate to Drain Charge		Q_{GD}	IG- IIIIA (Note 1, 2)				nC		
Turn-ON Delay Time (Note 1)		t _{D(ON)}			6		ns		
Rise Time		t _R	V_{DD} =200V, V_{GS} =10V, I_{D} =8.0A,		20.8		ns		
Turn-OFF Delay Time		t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		48		ns		
Fall-Time		t _F			37.2		ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Maximum Body-Diode Continuous Current		Is				8	Α		
Maximum Body-Diode Pulsed Current		I _{SM}				24	Α		
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =8.0A, V _{GS} =0V			1.4	V		
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =8.0A, V _{GS} =0V,		156		ns		
Body Diode Reverse Recovery Charge		Q _{rr}	dI _F /dt=100A/μs		0.97		μC		

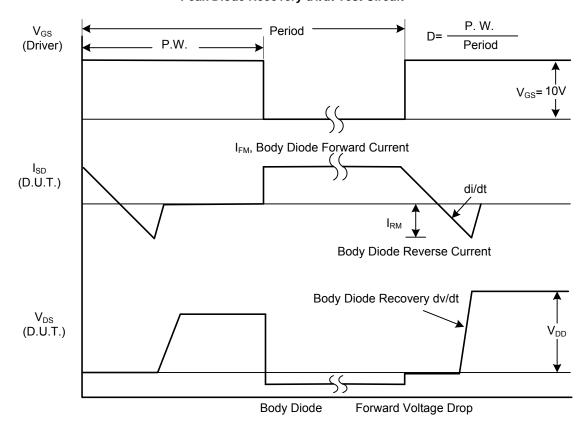
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



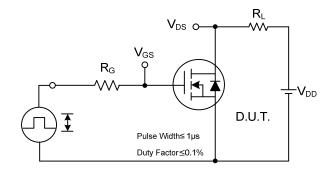
Peak Diode Recovery dv/dt Test Circuit

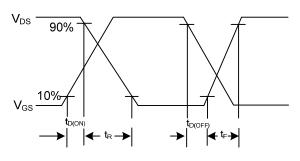


Peak Diode Recovery dv/dt Waveforms

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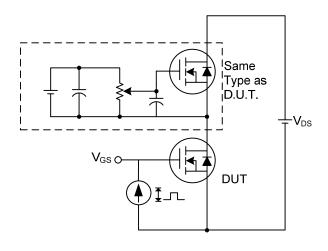
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

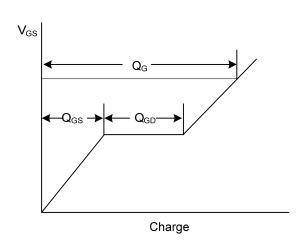




Switching Test Circuit

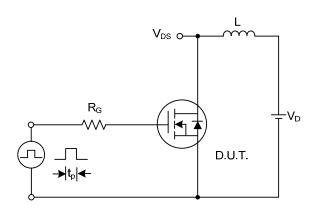
Switching Waveforms

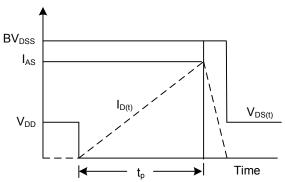




Gate Charge Test Circuit

Gate Charge Waveform

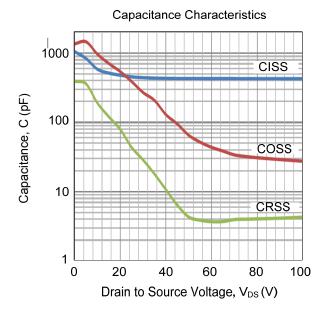




Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



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